



**THE DATASHEET OF  
SN74ALVCH16334DGVR**



## FEATURES

- Member of the Texas Instruments Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Output Port Has Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- Designed to Comply With JEDEC 168-Pin and 200-Pin SDRAM Buffered DIMM Specification
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

NOTE: For tape-and-reel order entry, the DGG package is abbreviated to GR, and the DGV package is abbreviated to VR.

## DESCRIPTION

This 16-bit universal bus driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

Data flow from A to Y is controlled by the output-enable ( $\overline{OE}$ ) input. The device operates in the transparent mode when the latch-enable ( $\overline{LE}$ ) input is low. When  $\overline{LE}$  is high, the A data is latched if the clock (CLK) input is held at a high or low logic level. If  $\overline{LE}$  is high, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

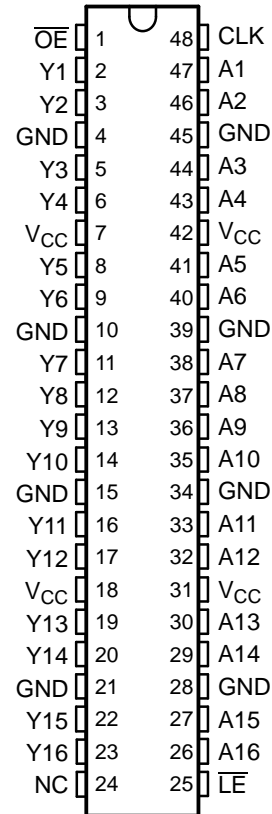
The output port includes equivalent 26-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH162334 is characterized for operation from -40°C to 85°C.

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



NC – No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

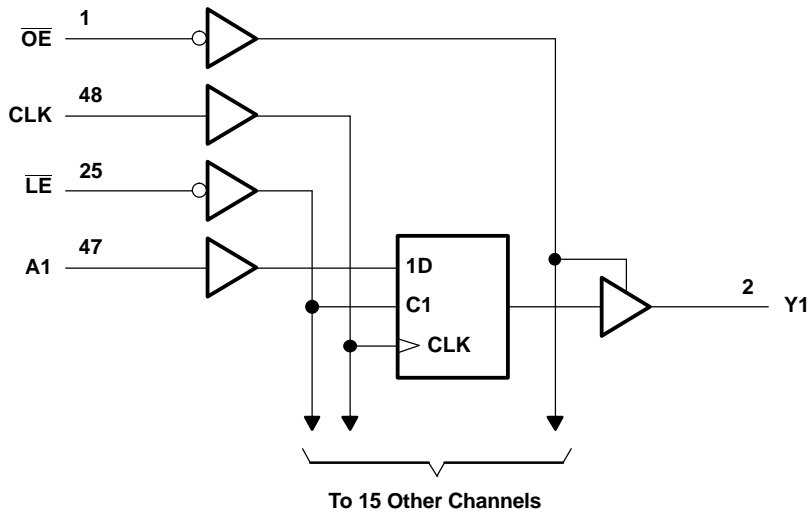
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**FUNCTION TABLE**

| INPUTS          |                 |        |   | OUTPUT<br>Y |
|-----------------|-----------------|--------|---|-------------|
| $\overline{OE}$ | $\overline{LE}$ | CLK    | A |             |
| H               | X               | X      | X | Z           |
| L               | L               | X      | L | L           |
| L               | L               | X      | H | H           |
| L               | H               | ↑      | L | L           |
| L               | H               | ↑      | H | H           |
| L               | H               | L or H | X | $Y_0^{(1)}$ |

(1) Output level before the indicated steady-state input conditions were established, provided that CLK is high before  $\overline{LE}$  goes high

**LOGIC DIAGRAM (POSITIVE LOGIC)**



**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|   |  | MIN         | MAX            | UNIT    |
|---|--|-------------|----------------|---------|
| $V_{CC}$  | Supply voltage range                     | -0.5        | 4.6            | V       |
| $V_I$   | Input voltage range <sup>(2)</sup>       | -0.5        | 4.6            | V       |
| $V_O$   | Output voltage range <sup>(2)(3)</sup>   | -0.5        | $V_{CC} + 0.5$ | V       |
| $I_{IK}$  | Input clamp current                      | $V_I < 0$   |                | -50 mA  |
| $I_{OK}$  | Output clamp current                     | $V_O < 0$   |                | -50 mA  |
| $I_O$   | Continuous output current                |             |                | ±50 mA  |
| Continuous current through each $V_{CC}$ or GND |  |             |                | ±100 mA |
| $\theta_{JA}$                                   | Package thermal impedance <sup>(4)</sup> | DGG package |                | 89 °C/W |
|   |  | DGV package |                | 93 °C/W |
|   |  | DL package  |                | 94 °C/W |
| $T_{stg}$                                       | Storage temperature range                | -65         | 150            | °C      |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 4.6 V maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51.

**RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

|                     |                                    | MIN                                       | MAX      | UNIT                 |
|---------------------|------------------------------------|---|----------|----------------------|
| $V_{CC}$            | Supply voltage                     | 1.65                                      | 3.6      | V                    |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ |          | $0.65 \times V_{CC}$ |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$   |          | 1.7                  |
|                     |                                    | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$   |          | 2                    |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ |          | $0.35 \times V_{CC}$ |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$   |          | 0.7                  |
|                     |                                    | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$   |          | 0.8                  |
| $V_I$               | Input voltage                      | 0   | $V_{CC}$ | V                    |
| $V_O$               | Output voltage                     | 0   | $V_{CC}$ | V                    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 1.65\text{ V}$                  |          | -2 mA                |
|                     |                                    | $V_{CC} = 2.3\text{ V}$                   |          | -6 mA                |
|                     |                                    | $V_{CC} = 2.7\text{ V}$                   |          | -8 mA                |
|                     |                                    | $V_{CC} = 3\text{ V}$                     |          | -12 mA               |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 1.65\text{ V}$                  |          | 2 mA                 |
|                     |                                    | $V_{CC} = 2.3\text{ V}$                   |          | 6 mA                 |
|                     |                                    | $V_{CC} = 2.7\text{ V}$                   |          | 8 mA                 |
|                     |                                    | $V_{CC} = 3\text{ V}$                     |          | 12 mA                |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |   |          | 10 ns/V              |
| $T_A$               | Operating free-air temperature     | -40                                       | 85       | °C                   |

- (1) All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**SN74ALVCH162334**  
**16-BIT UNIVERSAL BUS DRIVER**  
**WITH 3-STATE OUTPUTS**

SCES120H–JULY 1997–REVISED SEPTEMBER 2004

**ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            |                         | TEST CONDITIONS  | V <sub>CC</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|----------------------|-------------------------|--|-----------------|-----------------------|--------------------|------|------|
| V <sub>OH</sub>      |                         | I <sub>OH</sub> = -100 μA  | 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2 |                    |      | V    |
|                      |                         | I <sub>OH</sub> = -2 mA  | 1.65 V          | 1.2                   |                    |      |      |
|                      |                         | I <sub>OH</sub> = -4 mA  | 2.3 V           | 1.9                   |                    |      |      |
|                      |                         | I <sub>OH</sub> = -6 mA  | 2.3 V           | 1.7                   |                    |      |      |
|                      |                         |  | 3 V             | 2.4                   |                    |      |      |
|                      |                         | I <sub>OH</sub> = -8 mA  | 2.7 V           | 2                     |                    |      |      |
| V <sub>OL</sub>      |                         | I <sub>OL</sub> = 100 μA   | 1.65 V to 3.6 V |                       |                    | 0.2  | V    |
|                      |                         | I <sub>OL</sub> = 2 mA   | 1.65 V          |                       |                    | 0.45 |      |
|                      |                         | I <sub>OL</sub> = 4 mA   | 2.3 V           |                       |                    | 0.4  |      |
|                      |                         | I <sub>OL</sub> = 6 mA   | 2.3 V           |                       |                    | 0.55 |      |
|                      |                         |  | 3 V             |                       |                    | 0.55 |      |
|                      |                         | I <sub>OL</sub> = 8 mA   | 2.7 V           |                       |                    | 0.6  |      |
|                      | I <sub>OL</sub> = 12 mA | 3 V  |                 |                       | 0.8                |      |      |
| I <sub>I</sub>       |                         | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.6 V           |                       |                    | ±5   | μA   |
| I <sub>I(hold)</sub> |                         | V <sub>I</sub> = 0.58 V  | 1.65 V          | 25                    |                    |      | μA   |
|                      |                         | V <sub>I</sub> = 1.07 V  | 1.65 V          | -25                   |                    |      |      |
|                      |                         | V <sub>I</sub> = 0.7 V   | 2.3 V           | 45                    |                    |      |      |
|                      |                         | V <sub>I</sub> = 1.7 V   | 2.3 V           | -45                   |                    |      |      |
|                      |                         | V <sub>I</sub> = 0.8 V   | 3 V             | 75                    |                    |      |      |
|                      |                         | V <sub>I</sub> = 2 V   | 3 V             | -75                   |                    |      |      |
|                      |                         | V <sub>I</sub> = 0 to 3.6 V <sup>(2)</sup>                                   | 3.6 V           |                       |                    | ±500 |      |
| I <sub>OZ</sub>      |                         | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.6 V           |                       |                    | ±10  | μA   |
| I <sub>CC</sub>      |                         | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                  | 3.6 V           |                       |                    | 40   | μA   |
| ΔI <sub>CC</sub>     |                         | One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND | 3 V to 3.6 V    |                       |                    | 750  | μA   |
| C <sub>i</sub>       | Control inputs          | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           | 5.5                   |                    |      | pF   |
|                      | Data inputs             |  |                 | 6                     |                    |      |      |
| C <sub>o</sub>       | Outputs                 | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           | 8                     |                    |      | pF   |

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

(2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

## TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

|                    |                 | $V_{CC} = 1.8\text{ V}$                    |                 | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | UNIT |  |
|--------------------|-----------------|--|-----------------|--|-----|-------------------------|-----|--|-----|------|--|
|                    |                 | MIN  | MAX             | MIN                                      | MAX | MIN                     | MAX | MIN                                      | MAX |      |  |
| $f_{\text{clock}}$ | Clock frequency | (1)  |                 | 150                                      |     | 150                     |     | 150                                      |     | MHz  |  |
| $t_w$              | Pulse duration  | $\overline{\text{LE}}$ low                 |                 | (1)                                      |     | 3.3                     |     | 3.3                                      |     | ns   |  |
|                    |                 | CLK high or low                            |                 | (1)                                      |     | 3.3                     |     | 3.3                                      |     |      |  |
| $t_{\text{su}}$    | Setup time      | Data before CLK $\uparrow$                 |                 | (1)                                      |     | 1.4                     |     | 1.7                                      |     | ns   |  |
|                    |                 | Data before $\overline{\text{LE}}\uparrow$ | CLK high        |  | (1) |                         | 1.2 |  | 1.6 |      |  |
|                    |                 |  | CLK low         |  | (1) |                         | 1.4 |  | 1.5 |      |  |
| $t_h$              | Hold time       | Data after CLK $\uparrow$                  |                 | (1)                                      |     | 0.9                     |     | 0.8                                      |     | ns   |  |
|                    |                 | Data after $\overline{\text{LE}}\uparrow$  | CLK high or low |  | (1) |                         | 1.2 |  | 1.1 |      |  |

(1) This information was not available at the time of publication.

## SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

| PARAMETER        | FROM (INPUT)           | TO (OUTPUT) | $V_{CC} = 1.8\text{ V}$ |     | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | UNIT |
|------------------|------------------------|-------------|-------------------------|-----|--|-----|-------------------------|-----|--|-----|------|
|                  |                        |             | MIN                     | TYP | MIN                                      | MAX | MIN                     | MAX | MIN                                      | MAX |      |
| $f_{\text{max}}$ |                        |             | (1)                     |     | 150                                      |     | 150                     |     | 150                                      |     | MHz  |
| $t_{\text{pd}}$  | A                      | Y           | (1)                     |     | 1  | 3.9 | 4.5                     |     | 1.1                                      | 3.9 | ns   |
|                  | $\overline{\text{LE}}$ |             | (1)                     |     | 1  | 5   | 6                       |     | 1.3                                      | 5   |      |
|                  | CLK                    |             | (1)                     |     | 1  | 4.9 | 5.4                     |     | 1  | 4.9 |      |
| $t_{\text{en}}$  | $\overline{\text{OE}}$ | Y           | (1)                     |     | 1  | 5.4 | 6.4                     |     | 1.1                                      | 5.4 | ns   |
| $t_{\text{dis}}$ | $\overline{\text{OE}}$ | Y           | (1)                     |     | 1  | 5   | 5.1                     |     | 1.7                                      | 5   | ns   |

(1) This information was not available at the time of publication.

## OPERATING CHARACTERISTICS

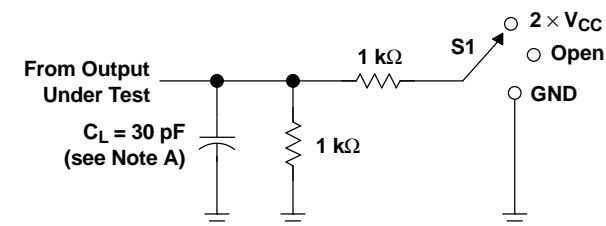
$T_A = 25^\circ\text{C}$

| PARAMETER       |                               | TEST CONDITIONS                    | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|-----------------|-------------------------------|------------------------------------|-------------------------|-------------------------|-------------------------|------|
|                 |                               |                                    | TYP                     | TYP                     | TYP                     |      |
| $C_{\text{pd}}$ | Power dissipation capacitance | $C_L = 0, \quad f = 10\text{ MHz}$ | (1)                     | 32                      | 37                      | pF   |
|                 | Outputs enabled               |                                    | (1)                     | 7                       | 11.5                    |      |
|                 | Outputs disabled              |                                    |                         |                         |                         |      |

(1) This information was not available at the time of publication.

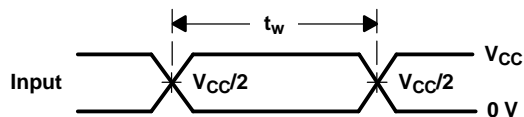
**PARAMETER MEASUREMENT INFORMATION**

$V_{CC} = 1.8\text{ V}$

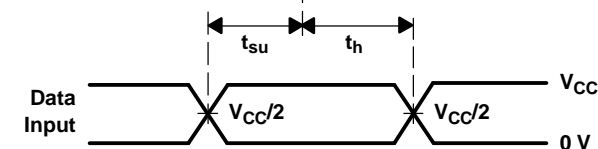


**LOAD CIRCUIT**

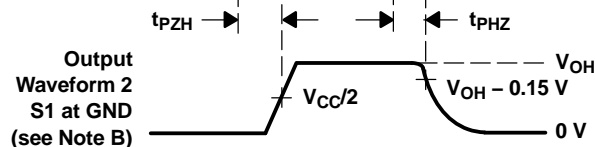
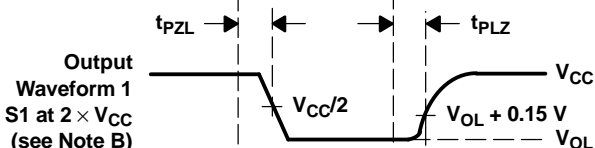
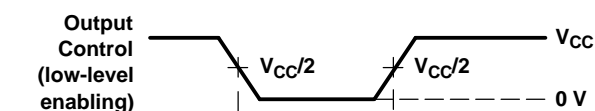
| TEST              | S1                |
|-------------------|-------------------|
| $t_{pd}$          | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



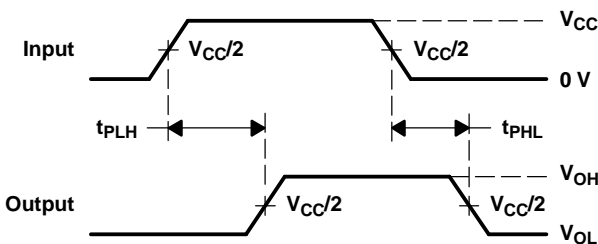
**VOLTAGE WAVEFORMS PULSE DURATION**



**VOLTAGE WAVEFORMS SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES**



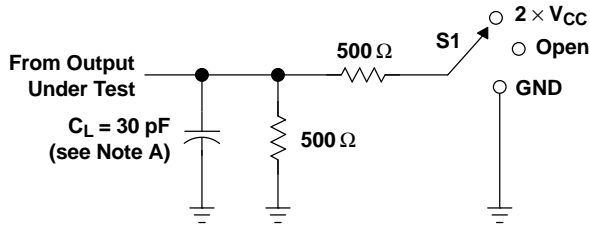
**VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES**

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
D. The outputs are measured one at a time, with one transition per measurement.  
E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 1. Load Circuit and Voltage Waveforms**

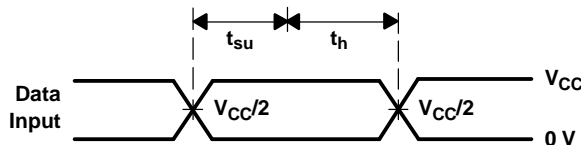
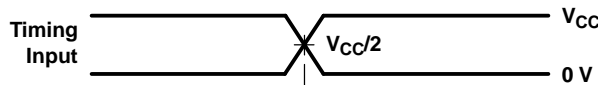
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$

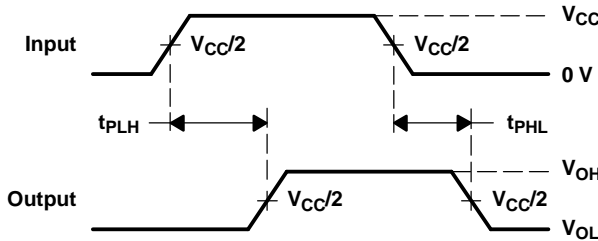


LOAD CIRCUIT

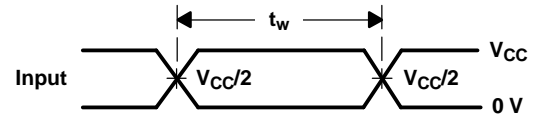
| TEST              | S1                |
|-------------------|-------------------|
| $t_{pd}$          | Open              |
| $t_{PLZ}/t_{PZL}$ | 2 $\times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



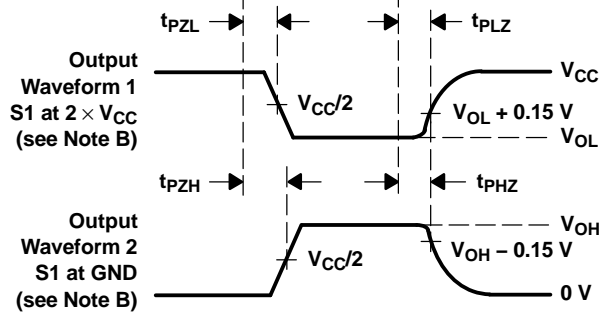
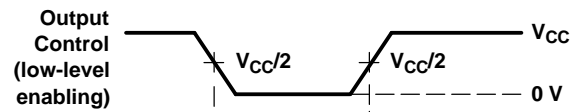
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



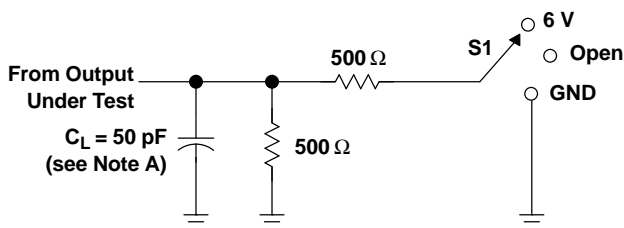
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
D. The outputs are measured one at a time, with one transition per measurement.  
E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms

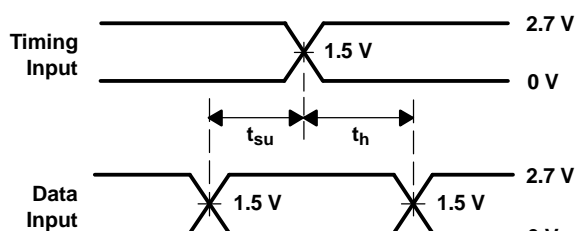
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V}$  AND  $3.3\text{ V} \pm 0.3\text{ V}$

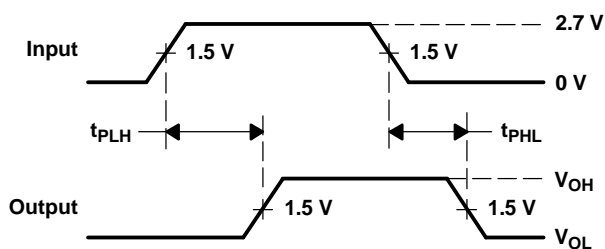


LOAD CIRCUIT

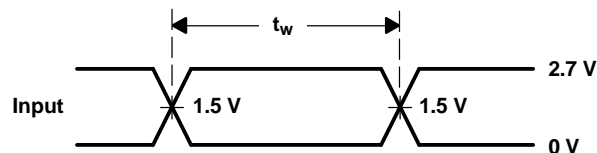
| TEST              | S1   |
|-------------------|------|
| $t_{pd}$          | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



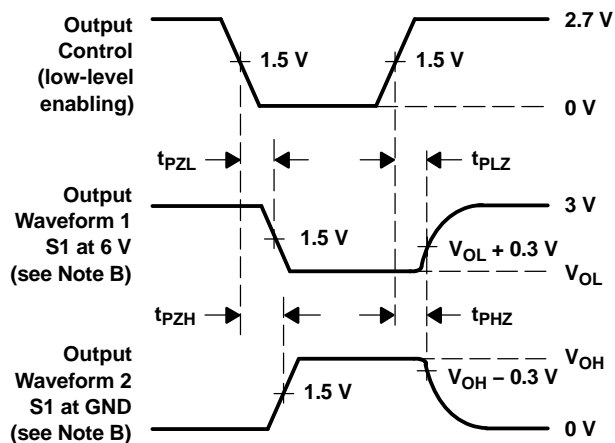
VOLTAGE WAVEFORMS  
 SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
 PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
 PULSE DURATION



VOLTAGE WAVEFORMS  
 ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
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 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 3. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device    | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|---------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74ALVCH162334DLG4   | ACTIVE                | SSOP         | DL              | 48   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVCH162334DLRG4  | ACTIVE                | SSOP         | DL              | 48   |             | TBD                     | Call TI          | Call TI                      |
| 74ALVCH162334GRE4   | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVCH162334GRG4   | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVCH162334VRE4   | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVCH162334VRG4   | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVCH162334DGGR | OBSOLETE              | TSSOP        | DGG             | 48   |             | TBD                     | Call TI          | Call TI                      |
| SN74ALVCH162334DGV  | OBSOLETE              | TVSOP        | DGV             | 48   |             | TBD                     | Call TI          | Call TI                      |
| SN74ALVCH162334DL   | ACTIVE                | SSOP         | DL              | 48   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVCH162334GR   | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVCH162334VR   | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ALVCH162334GR | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 15.8    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74ALVCH162334VR | TVSOP        | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |

TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALVCH162334GR | TSSOP        | DGG             | 48   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74ALVCH162334VR | TVSOP        | DGV             | 48   | 2000 | 346.0       | 346.0      | 33.0        |

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

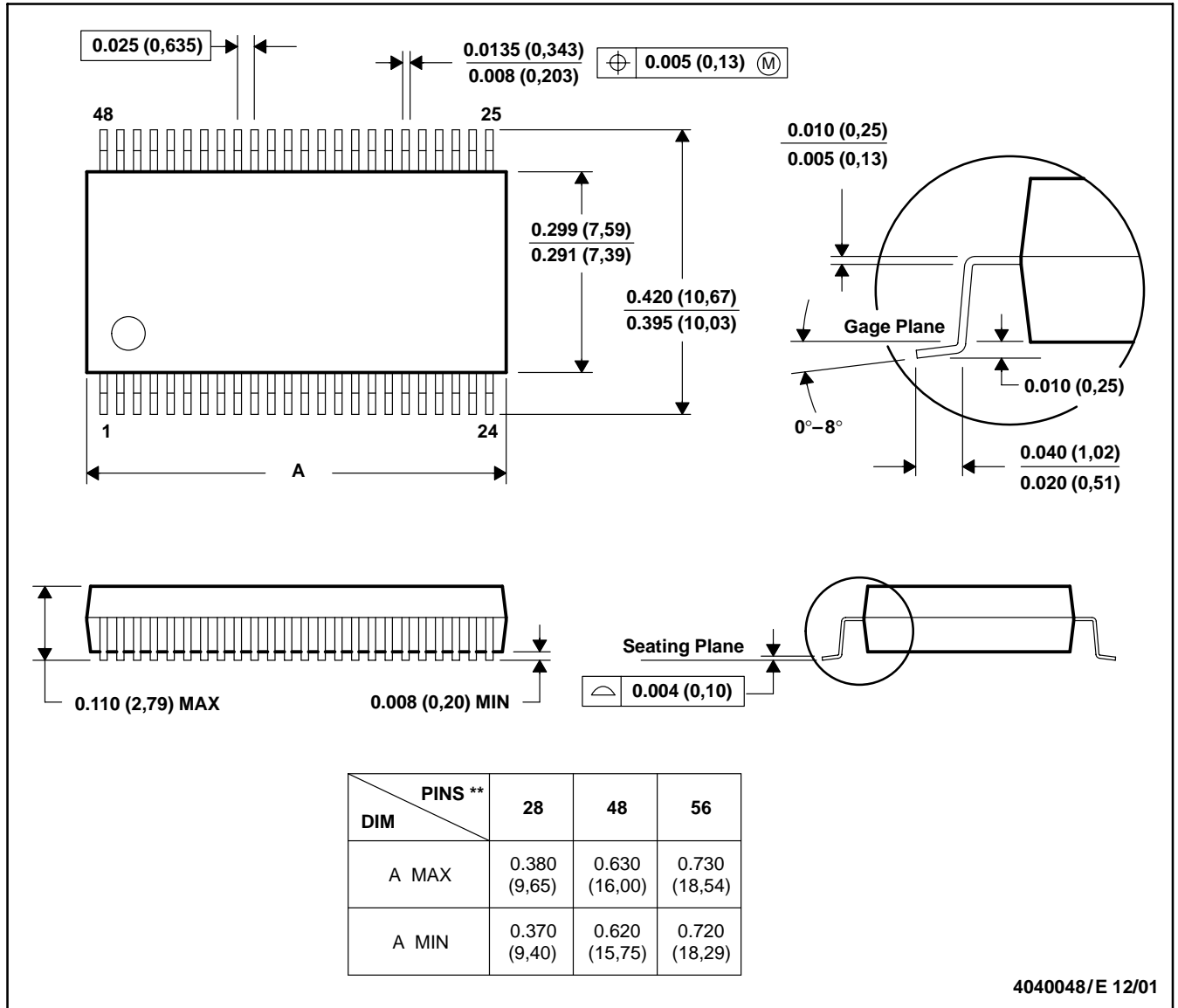


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

DL (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

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